Electronic Supplementary Information

Cu-doped calcium phosphate supraparticles for bone tissue regeneration

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Figure S1. XRD pattern of unpurified CaP NPs with a molar ratio of Ca/P = 1.50 after calcination at 1000 °C.



Figure S2. Ca (**A**) and P (**B**) cumulative release of Cu-doped CaP supraparticles (0 – 15.0 wt% Cu) in bi-distilled water over a period of 14 days.



Figure S3. Results of ZOI after performing the inhibition test with *B. subtilis* using the 5.0 – 15.0 wt% Cu eluate as well as the 0 wt% Cu eluate as control.



Figure S4. XRD pattern of freeze-dried 10.0 wt% Cu eluate.



Figure S5. Live/dead staining 24 h after incubation with CaP supraparticles without (**A**) and with 15.0 wt% Cu (**B**) as well as of the control (**C**). **Green**: Fluorescence signal of living cells. **Magenta**: Fluorescence signal of dead cells. **Blue**: Fluorescence of cell nucleus. Representative images of three independent experiments are shown. (**D**) Percentage of dead/living cells of live/dead staining 24 h after incubation with undoped and Cu-doped (15.0 wt%) CaP supraparticles. The diagrams display the results of quantitative analysis of fluorescence micrographs from 3 independent experiments and 9 photos of each sample ± SEM. The analysis was performed using ZEISS ZEN 2.6 Pro software and the ZEN Intellesis module.



Figure S6. (A) Live/dead staining 48 h after incubation with CaP supraparticles without (A) and with 15.0 wt% Cu (B) as well as of the control (C). **Green**: Fluorescence signal of living cells. **Magenta**: Fluorescence signal of dead cells. **Blue**: Fluorescence of cell nucleus. Representative images of three independent experiments are shown. (D) Percentage of dead/living cells of live/dead staining 48 h after incubation with undoped and Cu-doped (15.0 wt%) CaP supraparticles. The diagrams display the results of quantitative analysis of fluorescence micrographs from 3 independent experiments and 9 photos of each sample ± SEM. The analysis was performed using ZEISS ZEN 2.6 Pro software and the ZEN Intellesis module.

S7. Coating and characterization: Prior to the coating process, a water-based suspension containing commercial β -TCP raw powder (5.0 wt%, Budenheim) and stabilizing agents (phosphonate-based (3.0 wt% of solid content) and hydrocolloid (2.0 wt% of total suspension)) was prepared. Subsequently, the Cu-doped CaP supraparticles (0.5 wt%) dispersed in water were introduced into the aforementioned suspension. Coating on Ti substrates (ARA-T Advance GmbH) was then performed using the HVSFS process as described by Killinger et al.¹



Figure S7. (A) SEM image of dried water suspension containing Cu-doped CaP supraparticles (0.5 wt%) and commercial β -TCP raw powder (5.0 wt%). (B) SEM-image of β -TCP coating with incorporated Cu-doped CaP supraparticles on Ti substrate with detail of one incorporated supraparticle (top, right).

References

1. A. Killinger, M. Kuhn and R. Gadow, *Surface and Coatings Technology*, 2006, **201**, 1922.